

# Joint Fuze Technology Program (JFTP) 55th Annual NDIA Fuze Conference

25 May 2011

#### **Joint Fuze Technology Panel**

Charles Kelly (OUSD AT&L PSA LW&M)
Lawrence Fan (Navy)
Timothy Tobik (Air Force)
Philip Gorman (Army)

#### **Lawrence Fan (Presenter)**

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### **JFTP Overview**

- JFTP is a 6.2/6.3 national program established (FY10 start) to develop and mature technologies for improving future fuzing performance, survivability, and reliability
- JFTP governance and processes are modeled after the Joint Munitions Program (JMP) and the Joint Insensitive Munitions Technology Program (JIMTP)
  - Managers from Services and DTRA
- JFTP leverages and coordinates with projects in JMP, JIMTP and Service S&T
- Projects are selected based on evaluation of proposals from Gov't, Industry and Academia



## Joint Fuze Technology Program Management Structure





#### OUSD(AT&L)/ PSA/LW&M

Technical Advisory Committee







#### JOINT FUZE TECH PANEL OVERSIGHT COMMITTEE

**PROGRAM MANAGERS** 

Charles Kelly, Lawrence Fan, Phil Gorman, Tim Tobik

#### **FUZE AREA TECHNOLOGY GROUPS**

#### FATGI – Hard Target / Survivable Fuzing

Chair

Danny Hayles (DTRA)

Co-Chairs John Kandell (Navy) Bill Konick (Army) Howard White (AF)

SME Participants

### FATGII - Tailorable Effects & Initiation

Chair Gene Henderson (Army)

Co-Chairs Daniel Lanterman (Navy) George Jolly (AF)

SME Participants

#### FATGIII – High Reliability Fuzing

Chair John Hendershot (Navy)

Co-Chairs Steve Smith (AF) Tom Crowley (Army)

SME Participants

### FATGIV – Enabling Fuze Technologies

Chair

Chris Janow (Army)

Co-Chairs Matt Bridge (AF) Bruce Hornberger (Navy)

SME Participants



# **Fuze Area Technology Groups**

FATG I – Hard Target / Survivable Fuzing	FATG II – Tailorable Effects	FATG III – High Reliability Fuzing	FATG IV – Enabling Fuze Technologies	
1.1 Improved M&S	2.1 Initiation & Multi-point	3.1 Fuzing Architecture	4.1 Common / Modular Fuze Architecture	
1.2 Fuze Environment 1.3 Next Generation	point Initiators		4.2 Components Technologies	
Fuzing Hardware	2.3 MEMS Based Multipoint Initiators	features	4.3 Proximity Sensors	
	2.4 Smart Fuzing: Algorithms, timing and control		4.4 Weapons Effects & Damage Assessment	
	2.5 Adv Fuze Initiation		4.5 Fuzing Power Sources	

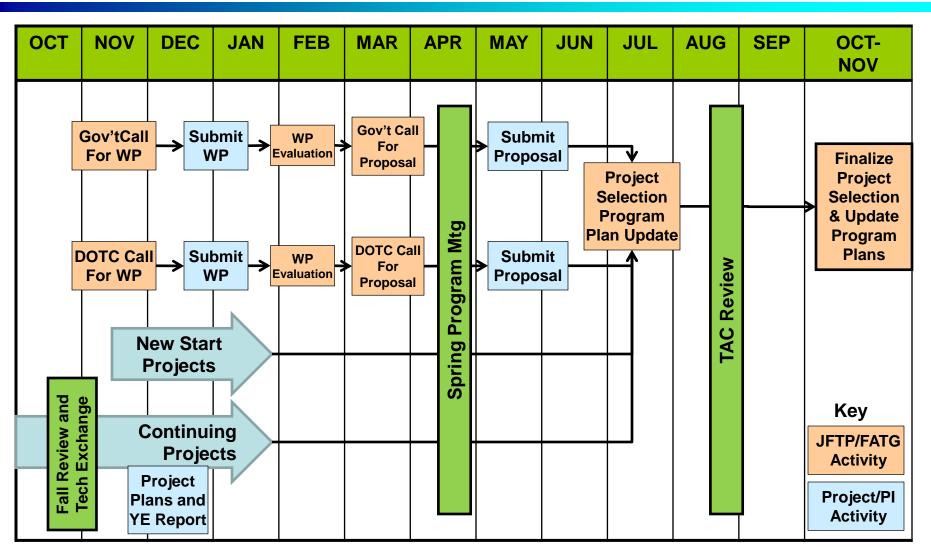


# **Funding**

	FY 10	FY 11	FY 12 PBR	FY 13	FY 14	FY 15	FY16
JFTP 6.2	3.849	7.833 (requested) 5.400 (actual total)	7.167	5.656	6.604	7.312	7.520
JFTP 6.3	0	3.577 (requested) 1.077 (actual total)	4.889	6.098	6.835	8.350	8.606



# JFTP Proposal and Review Annual Cycle





## **FY12 JFTP Summary**

- Funding levels from FY12 submitted budget:
  - 6.2 \$7.167M total
  - 6.3 \$4.889M total
- Selection ongoing for FY12 new starts
  - Proposers receive final go/no-go when FY12 budget is released ~ Nov 12
- Industry involvement:
  - Conveyed FATG goals and higher priority goals via DOTC Fuze call for proposals
  - Additional details at DOTC General Membership meeting July 11
- Program Plans (GOTChA charts) to link weapon requirements and needs to fuzing technologies to JFTP projects and gaps



## **Next Call for WP/Proposals**

#### **Call for White Papers**

- FY13 cycle starts in Dec 11/Jan 12
- Call is distributed to DoD, DOE and TAC members and to NWEC/DOTC
- FATG goals and needs conveyed
  - Focus on specific gaps not currently addressed
- 6.2 and 6.3 projects solicited (3 pages)

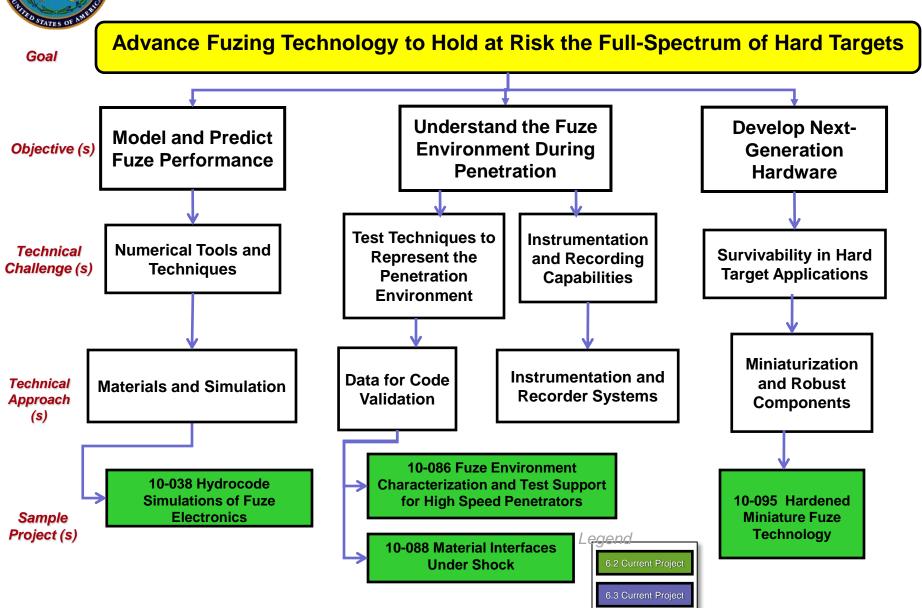
#### **White Paper Content**

- What FATG goals are being addressed
- Description of technology
- Statement of technology maturity
- Transitions (for 6.3 identify offices expected to provide endorsements and leveraging/cost sharing)
- Deliverables (what/when) and their relevance
- Yearly ROM costs and schedule





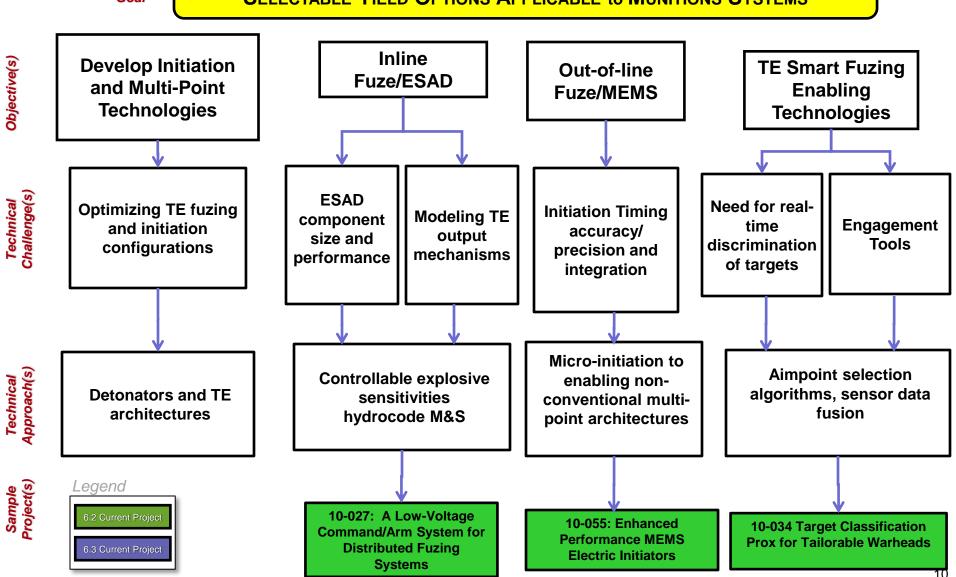
## FATG I Hard Target Fuzing GOTChA





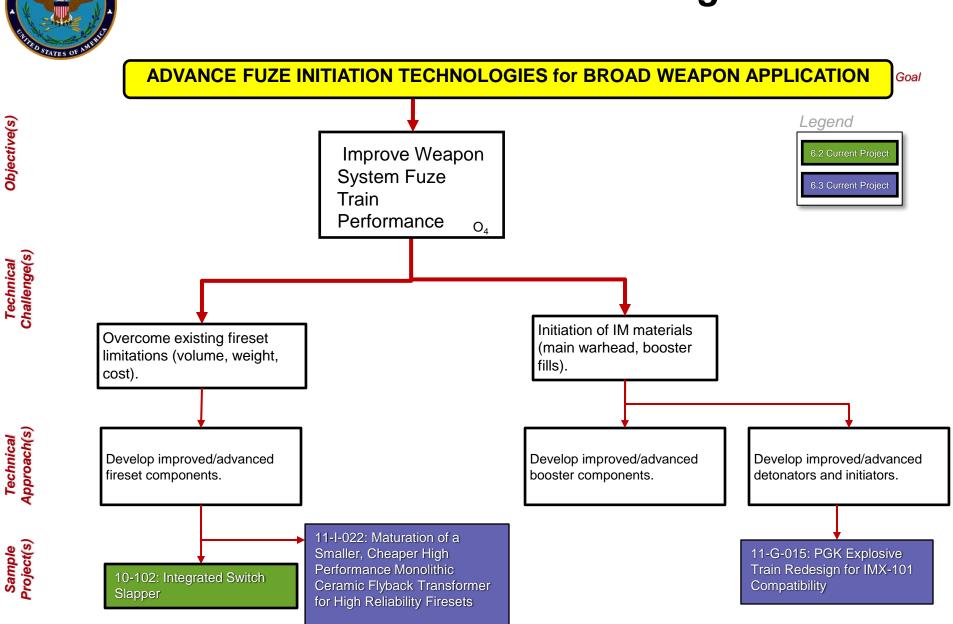
## FATG II Tailorable Effect Fuzing GOTChA

TAILORABLE EFFECTS (TE) WEAPON SYSTEMS TECHNOLOGIES THAT ENABLE SELECTABLE YIELD OPTIONS APPLICABLE to MUNITIONS SYSTEMS





## FATG II Tailorable Effect Fuzing GOTChA

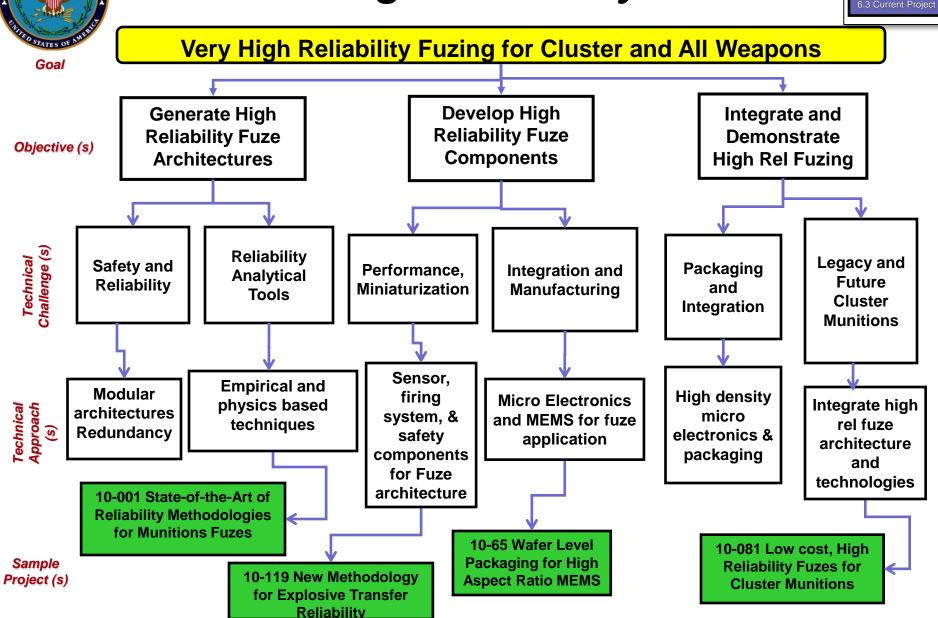




## FATG III High Reliability GOTChA

6.2 Current Project

6.3 Current Project





## FATG IV Enabling Fuze Tech GOTChA

Goal

#### **FATG IV Fuze Sensors and Power Sources**

Objective (s)

Develop Miniaturized, Robust and Affordable Fuzing Sensors

Technical Challenge (s)

Performance and technology development of proximity sensors, environmental safety sensors and retard / impact sensors

Investigate RF, IR and optical

sensors

Develop advanced antennae,

Technical Approach (s)

Sample Project (s) transceiver, and signal processing algorithms

0-042 Next 10-010: 6.

10-042 Next Generation Proximity Sensors

10-010: 6.3 MEMS Retard & Impact Sensor Improved Fuzing Power Source
Performance for a diverse range of applications
Increased Output (Power & Energy Density Improvements for higher power needs)

Rise time improvements and Energy density Decrease time to set fuze

6.2 Current Project

Legend

Apply advancements in power and materials technologies in compact form factors

Develop Thermal Battery Materials

Develop Electrolytes

10-070: Nanofoil-Heated Thin-Film/ Conformal Thermal Battery Construction

10-078: High Energy Density Super Capacitors



## **JFTP Calendar**

Call for FY12 White papers (Gov't and DOTC)
Gov't and DOTC WP Feedback sent and Call for proposals
Spring JFTP Meeting (Booz Allen Hamilton – Arlington, VA)
FY12 JFTP NWEC and Gov't proposals due
DOTC General Membership Meeting
TAC review of JFTP program
FY12 JFTP Budget Determined
FY12 JFTP Project Selection Decision
Call for FY13 White Papers



## 55<sup>th</sup> Annual Fuze Conference JFTP Project Briefs

- Session IIIB: High Reliability Fuzing Architecture for Cluster Munitions, David Gudjohnsen, US Army, ARDEC
- Session IVB: The Fuze Environment of Boosted Penetrators Dr. Jason Foley, US Air Force, AFRL Munitions Directorate
- Session IVB: Hardened Miniature Fuze Technology Progress Jefferson Oliver, US Air Force, AFRL Munitions Directorate
- Session IVB: Improving Fuze Environment Prediction During Hard Target Penetration Using A Coupled-Code Erosion Technique, Reid McKeown, US Navy, NSWC Indian Head Division
- Session VA: Wafer Level Packaging for High Aspect Ratio MEMS Kevin Cochran, US Navy, NSWC Indian Head Division
- Session VA: A Low Voltage Command-Arm System for Distributed Fuzing Mark Etheridge, US Army, AMRDEC
- Session VB: MEMS Retard and Impact Sensors, Walter Maurer, Naval Air Warfare Center Weapons Division



# Questions?